

GaAs-IR-Lumineszenzdiode

GaAs Infrared Emitter

Lead (Pb) Free Product - RoHS Compliant

LD 261



Wesentliche Merkmale

- GaAs-IR-Lumineszenzdiode
- Hohe Zuverlässigkeit
- Gruppiert lieferbar
- Gehäusegleich mit BPX 81
- Miniatur-Gehäuse

Features

- GaAs infrared emitting diode
- High reliability
- Available in bins
- Same package as BPX 81
- Miniature package

Anwendungen

- Miniaturlichtschranken für Gleich- und Wechsellichtbetrieb
- Barcodeleser
- Industrieelektronik
- „Messen/Steuern/Regeln“
- Sensorik
- Drehzahlsteuerung

Applications

- Miniature photointerrupters
- Barcode readers
- Industrial electronics
- For control and drive circuits
- Sensor technology
- Speed controller

Typ Type	Bestellnummer Ordering Code	Gehäuse Package
LD 261	Q62703Q0395	Leiterbandgehäuse, klares Epoxy-Gießharz, linsenförmig im 2.54-mm-Raster ($\frac{1}{10}$ "), Kathodenkennzeichnung: Nase am Lötspieß Lead frame, transparent epoxy resin lens, solder tabs lead spacing 2.54 mm ($\frac{1}{10}$ "), cathode marking: projection at solder lead
LD 261-5/6	Q65110A3337	

Grenzwerte ($T_A = 25\text{ °C}$)**Maximum Ratings**

Bezeichnung Parameter	Symbol Symbol	Wert Value	Einheit Unit
Betriebs- und Lagertemperatur Operating and storage temperature range	$T_{op}; T_{stg}$	- 40 ... + 80	°C
Sperrschichttemperatur Junction temperature	T_j	80	°C
Sperrspannung Reverse voltage	V_R	5	V
Durchlassstrom Forward current	I_F	50	mA
Stoßstrom, $\tau \leq 10\text{ }\mu\text{s}$, $D = 0$ Surge current	I_{FSM}	1.6	A
Verlustleistung Power dissipation	P_{tot}	70	mW
Wärmewiderstand Thermal resistance	R_{thJA} R_{thJL}	750 650	K/W K/W

Kennwerte ($T_A = 25\text{ °C}$)**Characteristics**

Bezeichnung Parameter	Symbol Symbol	Wert Value	Einheit Unit
Wellenlänge der Strahlung Wavelength at peak emission $I_F = 50\text{ mA}$, $t_p = 20\text{ ms}$	λ_{peak}	950	nm
Spektrale Bandbreite bei 50% von I_{max} Spectral bandwidth at 50% of I_{max} $I_F = 50\text{ mA}$, $t_p = 20\text{ ms}$	$\Delta\lambda$	55	nm
Abstrahlwinkel Half angle	φ	± 15	Grad deg.
Aktive Chipfläche Active chip area	A	0.25	mm ²
Abmessungen der aktiven Chipfläche Dimension of the active chip area	$L \times B$ $L \times W$	0.5×0.5	mm ²
Abstand Chipoberfläche bis Linsenscheitel Distance chip surface to lens top	H	1.3 ... 1.9	mm

Kennwerte ($T_A = 25\text{ °C}$)**Characteristics** (cont'd)

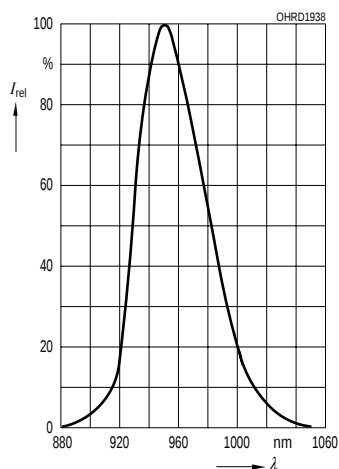
Bezeichnung Parameter	Symbol Symbol	Wert Value	Einheit Unit
Schaltzeiten, I_e von 10% auf 90% und von 90% auf 10%, bei $I_F = 50\text{ mA}$, $R_L = 50\text{ }\Omega$ Switching times, I_e from 10% to 90% and from 90% to 10%, $I_F = 50\text{ mA}$, $R_L = 50\text{ }\Omega$	t_r , t_f	1	μs
Kapazität, $V_R = 0\text{ V}$ Capacitance	C_o	40	pF
Durchlassspannung Forward voltage $I_F = 50\text{ mA}$, $t_p = 20\text{ }\mu\text{s}$	V_F	$1.25 (\leq 1.4)$	V
Sperrstrom, $V_R = 5\text{ V}$ Reverse current	I_R	$0.01 (\leq 1)$	μA
Gesamtstrahlungsfluss Total radiant flux $I_F = 50\text{ mA}$, $t_p = 20\text{ ms}$	Φ_e	9	mW
Temperaturkoeffizient von I_e bzw. Φ_e , $I_F = 50\text{ mA}$ Temperature coefficient of I_e or Φ_e , $I_F = 50\text{ mA}$	TC_I	- 0.55	%/K
Temperaturkoeffizient von V_F , $I_F = 50\text{ mA}$ Temperature coefficient of V_F , $I_F = 50\text{ mA}$	TC_V	- 1.5	mV/K
Temperaturkoeffizient von λ_{peak} , $I_F = 50\text{ mA}$ Temperature coefficient of λ_{peak} , $I_F = 50\text{ mA}$	TC_λ	0.3	nm/K

Gruppierung der Strahlstärke I_e in Achsrichtunggemessen bei einem Raumwinkel $\Omega = 0.01\text{ sr}$ **Grouping of radiant intensity I_e in axial direction**at a solid angle of $\Omega = 0.01\text{ sr}$

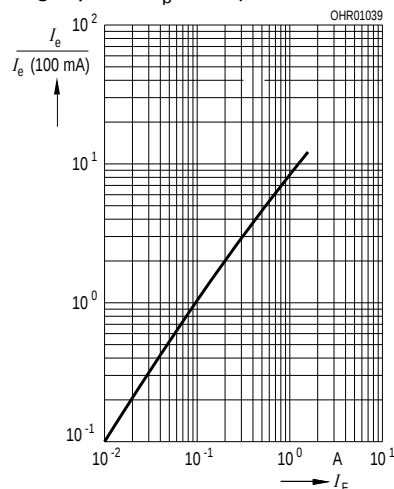
Bezeichnung Parameter	Symbol	Werte Values			Einheit Unit
		LD 261	LD 261-5	LD 261-6	
Strahlstärke Radiant intensity $I_F = 50\text{ mA}$, $t_p = 20\text{ ms}$	I_e	2 ... 10	3.2 ... 6.3	5 ... 10	mW/sr

Relative Spectral Emission

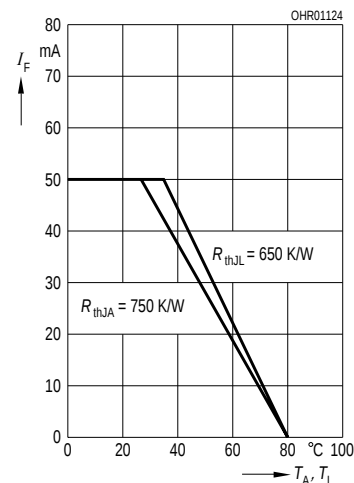
$$I_{\text{rel}} = f(\lambda)$$



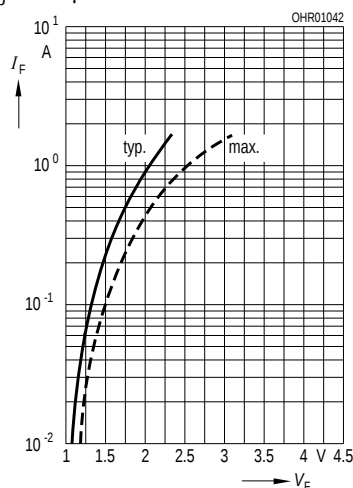
$$\text{Radiant Intensity } \frac{I_e}{I_e(100 \text{ mA})} = f(I_F)$$

Single pulse, $t_p = 20 \mu\text{s}$ **Max. Permissible Forward Current**

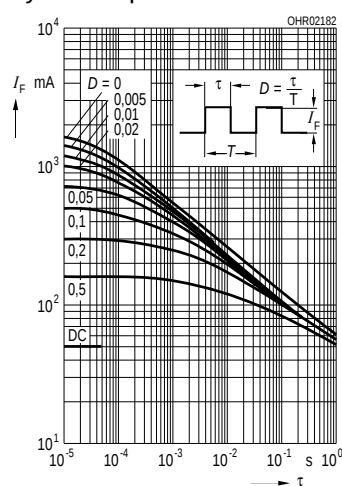
$$I_F = f(T_A)$$

**Forward Current**

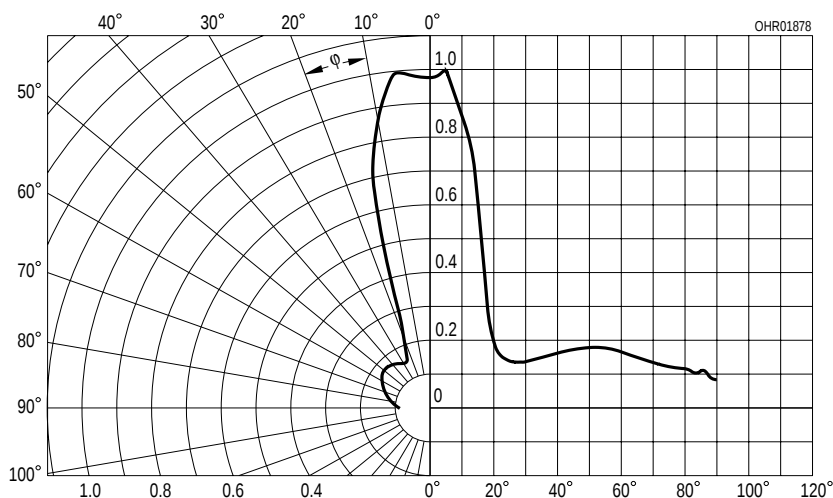
$$I_F = f(V_F), \text{ single pulse, } t_p = 20 \mu\text{s}$$

**Permissible Pulse Handling**

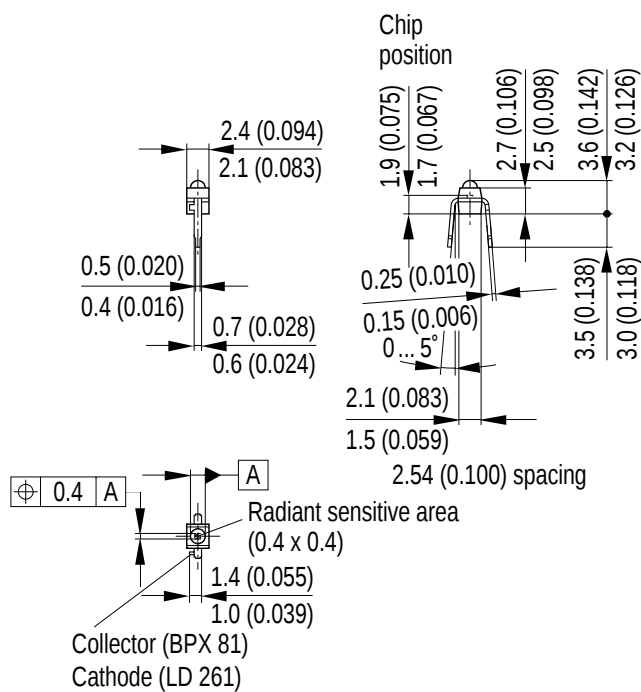
$$\text{Capability } I_F = f(\tau), T_C = 25^\circ\text{C}, \text{ duty cycle } D = \text{parameter}$$

**Radiation Characteristics**

$$I_{\text{rel}} = f(\varphi)$$



Maßzeichnung Package Outlines



1) Detaching area for tools, flash not true to size.

Approx. weight 0.03 g

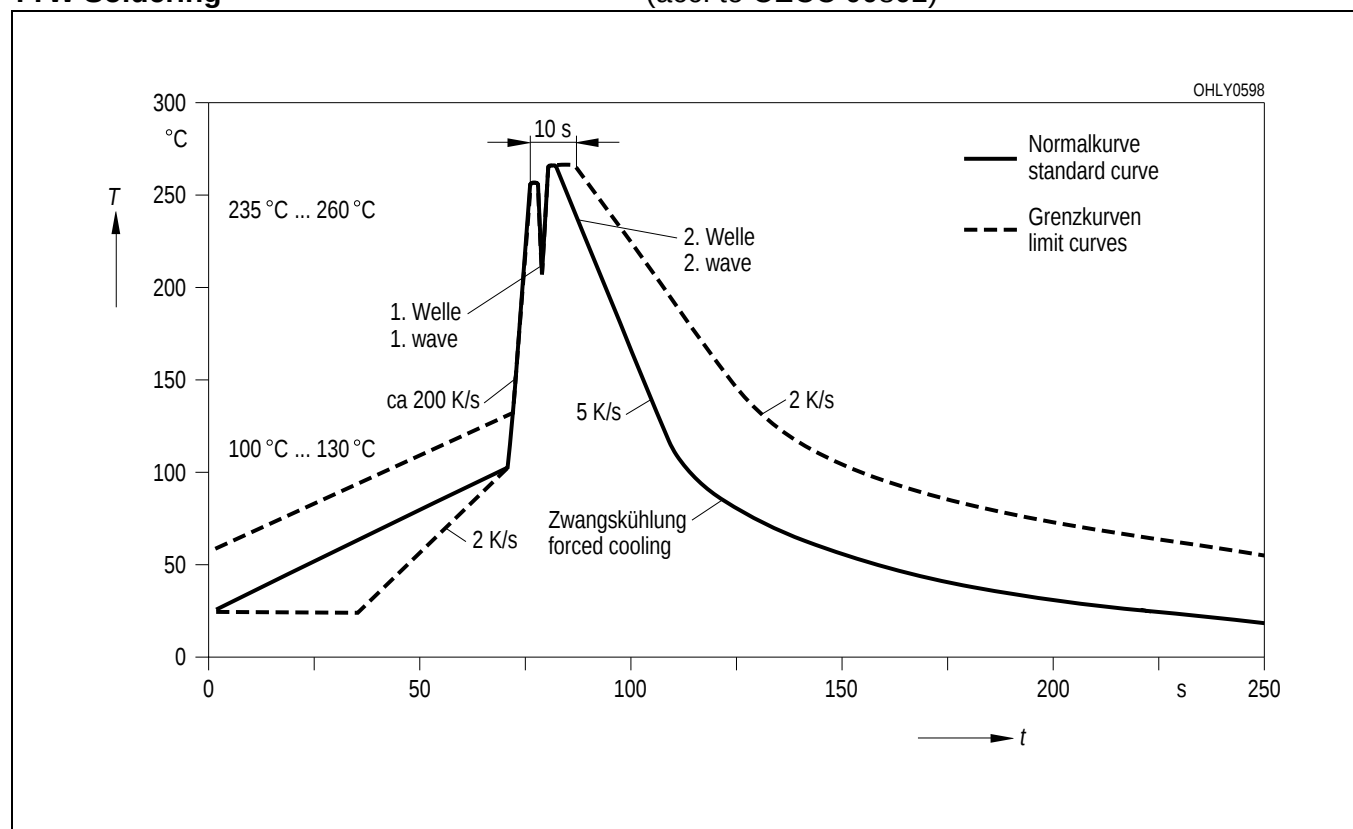
GEOY6021

Maße in mm (inch) / Dimensions in mm (inch).

Lötbedingungen
Soldering Conditions
Wellenlöten (TTW)
TTW Soldering

(nach CECC 00802)

(acc. to CECC 00802)



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